SL2363C & SL2364C

VERY HIGH PERFORMANCE TRANSISTOR ARRAYS

The SL2363C and SL2364C are arrays of transistors internally connected to form a dual long-tailed pair with tail transistors. They are monolithic integrated circuits manufactured on a very high speed bipolar process which has a minimum useable fr of 2.5GHz, (typically 5GHz). The SL2363 is in a 10 lead TO5 encapsulation.

The SL2364 is in a 14 lead DIL plastic encapsulation and a high performance Dilmon encapsulation.

FEATURES

- Complete Dual Long-Tailed Pair in One Package.
- Very High f_T Typically 5 GHz
- Very Good Matching Including Thermal Matching

APPLICATIONS

- Wide Band Amplification Stages
- 140 and 560 MBit PCM Systems
- Fibre Optic Systems
- High Performance Instrumentation
- Radio and Satellite Communications

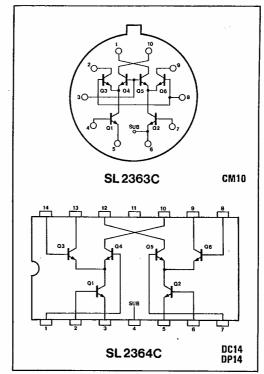


Fig. 1 Pin connections (top view)

ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = 22^{\circ}C \pm 2^{\circ}C$

Characteristics	Value				
	Min.	Тур.	Max.	Units	Conditions
BVCBO LVCEO BVEBO BVCIO hFE fT ΔVBE (See note 1) ΔVBE/TAMB CCB CCI	10 6 2.5 16 50 2.5	20 9 5.0 40 80 5 2 -1.7 0.5 1.0	5 0.8 1.5	V V V V GHz mV mV°C pF pF	IC = 10µA IC = 5mA IE = 10µA IC = 8mA, VCE = 2V IC (Tail) = 8mA, VCE = 2V IC (Tail) = 8 mA, VCE = 2V VCB = 0 VCI = 0

NOTE 1. ΔVBE applies to VBEQ3 - VBEQ4 and VBEQ5 - VBEQ6

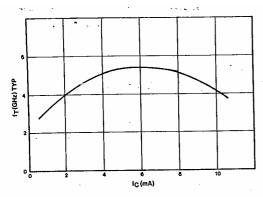


Fig. 2 Collector current

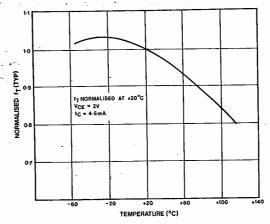


Fig. 3 Chip temperature

ABSOLUTE MAXIMUM RATINGS

Maximum individual transistor dissipation 200mW

Storage temperature -55°C to +150°C
Maximum junction temperature +150°C
Package thermal resistance (°C/W):
Chip to case 65 (CM10)
Chip to ambient 225 (CM10) 175 (DP14)
VCBO = 10V, VEBO = 2.5V, VCEO = 6V, VCIO = 15V, IC (any one transistor) = 20mA -55°C to +150°C +150°C

The substrate should be connected to the most negative point of the circuit to maintain electrical isolation between the transistors.